

Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from, Europe, America and south Asia, supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of "Quality Parts, Customers Priority, Honest Operation, and Considerate Service", our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip, ALPS, ROHM, Xilinx, Pulse, ON, Everlight and Freescale. Main products comprise IC, Modules, Potentiometer, IC Socket, Relay, Connector. Our parts cover such applications as commercial, industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



Contact us

Tel: +86-755-8981 8866 Fax: +86-755-8427 6832

Email & Skype: info@chipsmall.com Web: www.chipsmall.com

Address: A1208, Overseas Decoration Building, #122 Zhenhua RD., Futian, Shenzhen, China









STCL132K

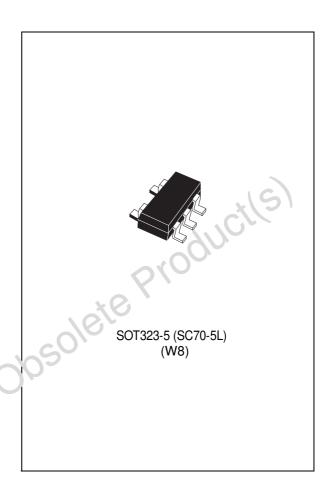
32,768 Hz silicon oscillator

Features

- Fixed frequency 32,768 Hz
- ±1.0% (0 to 70 °C), ±1.2% (−30 to 85 °C) frequency accuracy over all conditions
- 1.65 to 1.95 V, 2.7 to 3.6 V operation
- Low operating current, ultra low standby current
- Push-pull, CMOS compatible frequency (square wave) output
- Chip enable input, active high, internal 150 kΩ pull-down
- Fast and stable startup
- No external components required
- Temperature range: -30 to +85 °C
- Package: SC70-5L
- RoHS compliant

Applications

- Low-speed microprocessor clock
- Display drivers
- Any application with multiple incuts sharing a common clock source



Description

The STCL 32k silicon oscillator devices are reliable, easy to use, 5-pin low-cost silicon oscillators developed primarily for microprocessor clock applications, display drivers or other system applications where tighter clock accuracy is not critical. Compared to crystal oscillators, silicon oscillators offer the salvantages of faster startup, smaller size and improved immunity to shock, vibration and EMI.

The STCL132K silicon oscillator devices are equipped with chip enable input, offering an easy way to stop microprocessor clocking during a power saving mode while at the same time significantly reducing the oscillator current consumption.

Contents STCL132K

Contents

1	Pin descriptions	5
2	Typical application circuit	6
3	Operation 3.1 Chip enable 3.2 Transition to disable 3.3 Fast startup and stable wakeup from disable	7
4	Maximum rating	8
5	DC and AC parameters	9
6	Typical operating characteristics and scope plots	1
7	Package mechanical data1	4
8	Package details SC70-5L (RoHS compliant)	6
9	Part numbering	7
10	Package marking 18	8
11 0050	Revision history	9

STCL132K List of tables

List of tables

Table 1.	Signal names	. 5
Table 2.	Absolute maximum ratings	
Table 3.	DC and AC measurement conditions	
Table 4.	DC and AC parameters	10
Table 5.	SC70-5L – 5-lead small outline transistor package mechanical data	15
Table 6.	Ordering information scheme	17
Table 7.	Package marking	18
Table 8.	Document revision history	

Obsolete Produci(s) - Obsolete Produci(s)

List of figures STCL132K

List of figures

Figure 1. Figure 2. Figure 3. Figure 4. Figure 5. Figure 6. Figure 7. Figure 8.	SC70-5L pin connections	. 6 11 12 12 13
Figure 9. Figure 10.	(power-on, V _{CC} = 1.8 V, STCL132KRxxx)	14
•		
	ete Produci(s)	
	*e PYO	
	absoler	
	Ob	
	aducils	
	ate Pros	
Obsol		

STCL132K Pin descriptions

1 Pin descriptions

Figure 1. SC70-5L pin connections

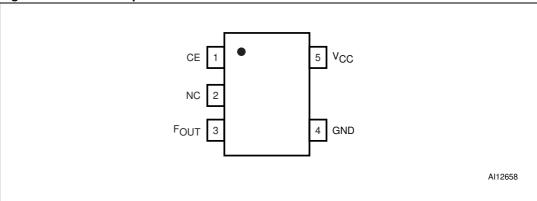


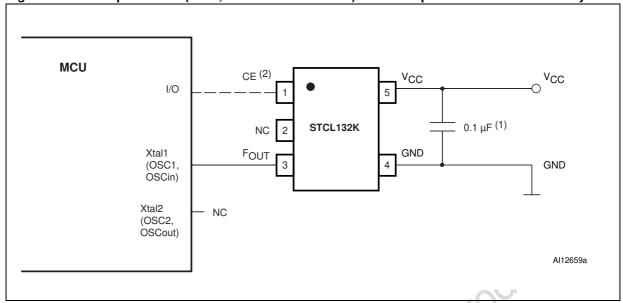
Table 1. Signal names

	Symbol	Description
	V _{CC}	Positive supply voltage pin
	F _{OUT}	Frequency (square wave) output, CMOS compatible, push-pull
	CE	Chip Enable input, CMOS level, active high, internal 150 k Ω pull-down resistor
	GND	Ground
	NC	No Connect
Obsolei	ePro	ducile

2 Typical application circuit

Obsolete Product(s)

Figure 2. Microprocessor (MCU, microcontroller unit) clock – replacement of a 32 KHz crystal



- For reliable operation and to further improve immunity to harsh environment, the minimum 0.1 μF decoupling capacitor is recommended to be placed as close as possible to the V_{CC} and GND pins of the oscillator device. The whole oscillator block should then be placed near the microprocessor clock input.
- 2. Internal 150 k Ω pull-down resistor is implemented on the CE input. If the chip enable feature is not used, in active mode connect the CE pin to V_{CC}. In applications utilizing standby mode and where the CE pin is connected to the controlling I/O port of the clocked microprocessor, for successful startup of the microprocessor at power-on, initial logic high level needs to be secured on the CE pin to ensure clocking occurs during the power-on reset until the microprocessor program starts and the controlling I/O port takes over the CE control.

STCL132K Operation

3 Operation

Use of the STCL132K silicon oscillator device is very simple. Once power is applied to V_{CC} pin, a CMOS-compatible square wave output signal is provided on the F_{OUT} output pin (in active mode the Chip Enable (CE) input pin must be at a logic high level).

3.1 Chip enable

This feature allows the user to stop the clock and significantly reduce the current consumption when the application is put into power saving mode.

When used to clock the microprocessor in place of a crystal, the need for chip enable input stems from a difference in the way microprocessors normally disable their clock. In the case of a crystal or ceramic resonator, when going into power saving mode, the processor simply opens the internal Xtal inverter feedback which results in stopping the crystal oscillations; however in the case of the silicon oscillators this would not work and the oscillator would continue to run. So in order to use this feature, one of the microprocessor's output pins must be configured to control the silicon oscillator's Chip Enable (CE) input, see typical application circuit diagram in *Figure 2*.

3.2 Transition to disable

At the moment when the Chip Enable (CE) input goes low, the oscillator's output F_{OUT} will immediately go low; then during the disable period the output remains low.

Note:

For advanced microprocessor applications, other disable modes can be made available as a product option (F_{OUT} completes the last clock period, and then remains low or provides 32 additional cycles before going low to allow the processor to complete the pipelined instructions, etc.). Also, a product option with output in a high-impedance state to allow the system to alternate between several oscillators connected in parallel can be made available. Contact local ST sales office for availability.

3.3 Fast startup and stable wakeup from disable

The total startup time until oscillations internally stabilize and remain within specifications is typically 90 μ s, i.e. shorter than duration of the first three periods of the generated output signal, see *Section 5: DC and AC parameters*. This means that 90 μ s after power-on or wakeup from disable a first valid period of the output signal occurs on the F_{OUT} pin and is within the specified frequency and duty cycle range (in the meantime the output remains low). This is in comparison to typically milliseconds for crystal oscillators.

Maximum rating STCL132K

Maximum rating 4

Stressing the device above the rating listed in Table 2: Absolute maximum ratings may cause permanent damage to the device. These are stress ratings only and operation of the device at these or any other conditions above those indicated in the operating sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability. Refer also to the STMicroelectronics SURE program and other relevant quality documents.

Table 2. **Absolute maximum ratings**

	Symbol	Parameter	Value	Unit			
	T _{STG}	Storage temperature (V _{CC} off)	-55 to 150	°C			
	T _{SLD} ⁽¹⁾	Lead solder temperature for 10 seconds	260	°C			
	V _I	Input voltage	-0.3 to $V_{CC} + 0.3$	V			
	V _{CC}	Supply voltage	-0.3 to 4.6	V			
	ESD - MM	Machine Model JESD22-A115-A level A ⁽²⁾	100	V			
	ESD - HBM	Human Body Model JESD22-A114-B level 2 ⁽²⁾	2	kV			
	ESD - CDM	Charged Device Model ⁽²⁾	1	kV			
	Reflow at peak For all externa	temperature of 260 °C (total thermal budget not to exceed 245 °C	for more than 30 seco	nds).			
Obsole	2. For all external pins. Obsolete Producits Obsolete Producits						

^{1.} Reflow at peak temperature of 260 °C (total thermal budget not to exceed 245 °C for more than 30 seconds).

5 DC and AC parameters

This section summarizes the operating and measurement conditions, as well as the DC and AC characteristics of the device. The parameters in the following DC and AC characteristic Table 4 are derived from tests performed under the measurement conditions listed in the Table 3. Designers should check that the operating conditions in their projects match the measurement conditions when using the quoted parameters.

DC and AC measurement conditions⁽¹⁾ Table 3.

	Ambient operating temperature 0 to 70 °C, -30 to +85 °C 0 to 70 °C, -30 to +85 °C	Parameter	STCL132KRxxx	STCL132KWxxx
		V _{CC} supply voltage	1.65 to 1.95 V	2.7 to 3.6 V
Load capacitance (C _L) 1. Unless otherwise specified.	Load capacitance (C _L) 1. Unless otherwise specified.			0 to 70 °C, –30 to +85 °C
1. Unless otherwise specified.	1. Unless otherwise specified. Obsolete Product(s)	Load capacitance (C _L)	12 pF	12 pF
	Producils		ansoletie P	roduci(s)

Table 4. DC and AC parameters

Symbol	Description	Test condition	Min	Тур	Max	Unit
.,		STCL132KRxxx	1.65		1.95	V
V _{CC}	Operating voltage	STCL132KWxxx	2.7		3.6	V
1	Operating current	V _{CC} = 1.65 to 1.95 V, (STCL132KRxxx) output unloaded		60	85	μА
Icc	Operating current	V _{CC} = 2.7 to 3.6 V, (STCL132KWxxx) output unloaded		85	105	μА
I _{CC2}	Standby current	CE = GND			1	μΑ
V _{OL}	Output voltage low	I _{OL} = 2 mA			0.2 V _{CC}	V
V _{OH}	Output voltage high	I _{OH} = -2 mA	V _{CC} – 0.2 V			V
V_{IL}	Input low voltage (CE)				0.35 V _{CC}	V
V_{IH}	Input high voltage (CE)		0.65 V _{CC}		2	S V
R_{PD}	Internal pull-down resistor			150	Nor.	kΩ
		V _{CC} = 1.65 to 1.95 V, –30 to +85 °C (STCL132KRxxx)	-1.2		+1.2	%
	Frequency accuracy ⁽¹⁾	V _{CC} = 1.65 to 1.95 V, 0 to +70 °C (STCL132KRxxx)	1.0		+1.0	%
	Trequency accuracy	V _{CC} = 2.7 to 3.6 V, -30 to +85 °C (STCL132KWxxx)	-1.2		+1.2	%
		V _{CC} = 2.7 to 3.6 V, 0 to +70 °C (STCL132KWxxx)	-1.0		+1.0	%
	Frequency temperature coefficient	,(5)	-150		+180	ppm/°C
	Jitter	Cycle-to-cycle, over 20 s		150		ns _{P-P}
	Duty cycle	Taken at half of the signal amplitude	45	50	55	%
t _{START}	Startup time	From the point when V _{CC} reached min operating voltage or CE went high until valid output signal occurs on the F _{OUT} pin (in the meantime output remains low)		90	120	μs
t _R , t _F	Rise/fall time	C _L = 12 pF; 10 to 90 % of the amplitude		10		ns
C_L	Load capacitance			12		pF

Typical frequency shift due to aging is ±0.2%. Aging stresses include one solder reflow (260 °C peak) and 1000 hrs V_{CC} biased, 125 °C op-life.

6 Typical operating characteristics and scope plots



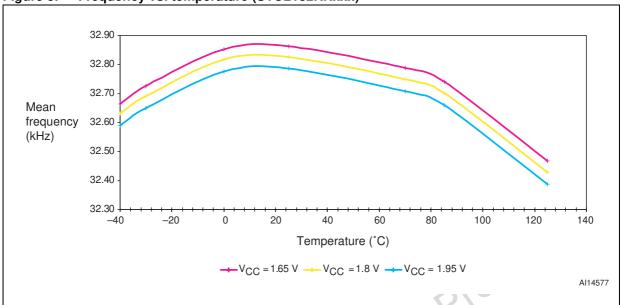
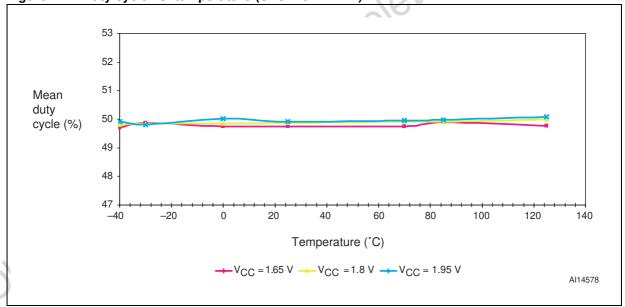


Figure 4. Duty cycle vs. temperature (STCL132KRxxx)



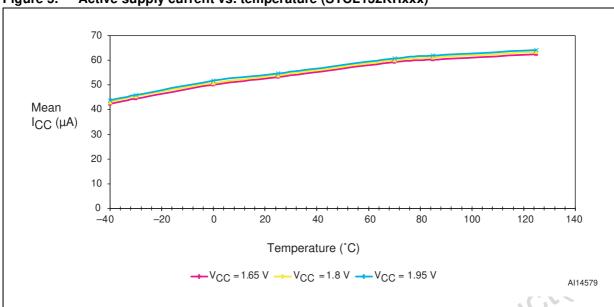
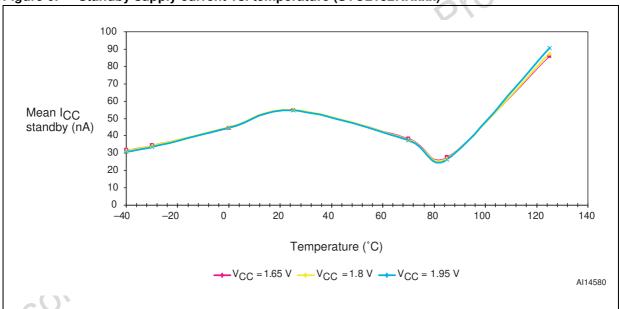


Figure 5. Active supply current vs. temperature (STCL132KRxxx)





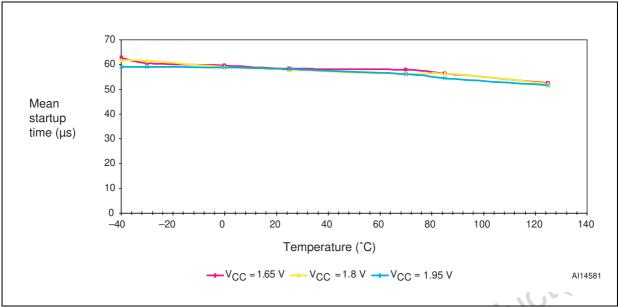
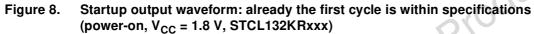
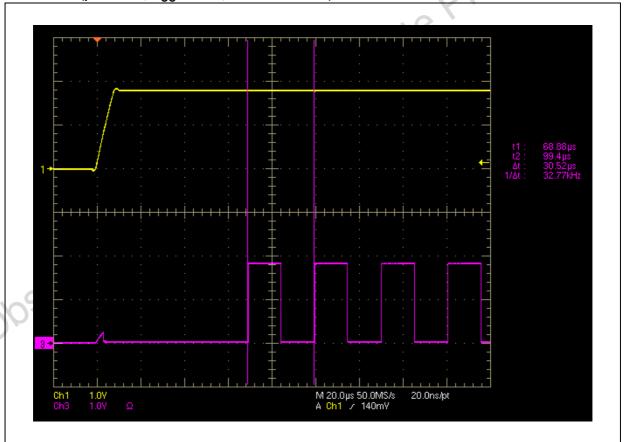


Figure 7. Startup time vs. temperature (STCL132KRxxx)





Package mechanical data 7

In order to meet environmental requirements, ST offers these devices in ECOPACK® packages. These packages have a lead-free second level interconnect. The category of second level interconnect is marked on the package and on the inner box label, in compliance with JEDEC Standard JESD97. The maximum ratings related to soldering conditions are also marked on the inner box label. ECOPACK is an ST trademark. ECOPACK specifications are available at: www.st.com.

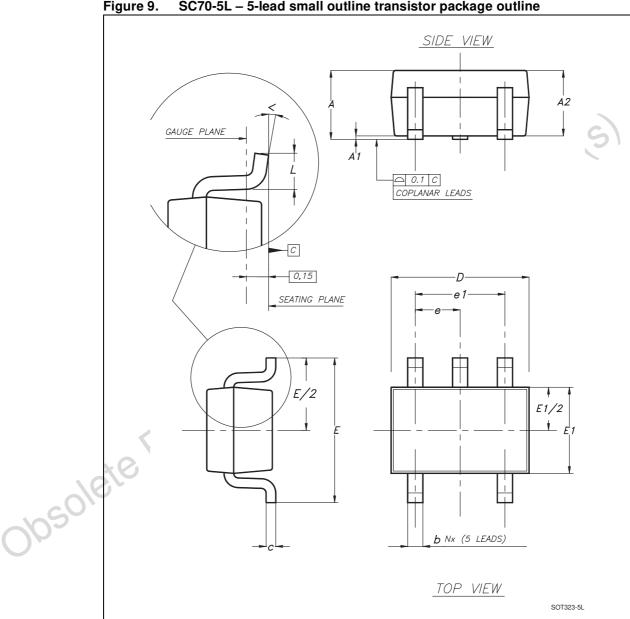


Figure 9. SC70-5L - 5-lead small outline transistor package outline

1. Drawing is not to scale.

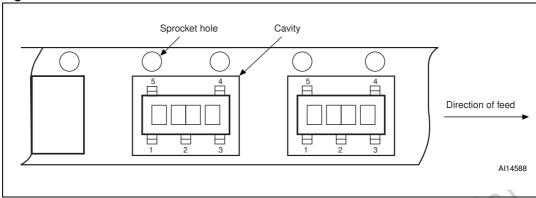
Table 5. SC70-5L – 5-lead small outline transistor package mechanical data

Symbol	mm			Inches		
-	Тур	Min	Max	Тур	Min	Max
Α	_	0.80	1.10	_	0.031	0.043
A1	_	0	0.10	_	0	0.004
A2	0.90	_	_	0.035	_	_
b	_	0.15	0.30	_	0.006	0.012
С	_	0.10	0.20	_	0.004	0.008
D	2.00	1.80	2.20	0.079	0.071	0.087
E	2.10	1.80	2.40	0.083	0.071	0.094
E1	1.25	1.15	1.35	0.049	0.045	0.053
е	0.65	_	_	0.026	_	
e1	1.30	_	_	0.051	_	16
L	0.36	0.26	0.46	0.014	0.010	0.018
S	_	0°	5°	_	0°	5°
			16	16		
s PYC	,,,ctl	(S) C	psole	ie.		

8 Package details SC70-5L (RoHS compliant)

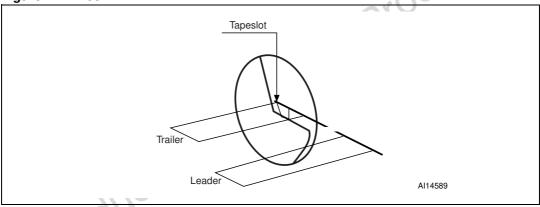
Tape and reel specifications according to EIA-481B standard:

Figure 10. Parts orientation in reel



Pin 1 located opposite to sprocket hole (lower left corner / quadrant 3 with reference to EIA-481B standard).

Figure 11. Reel



Leader length = 500 mm minimum

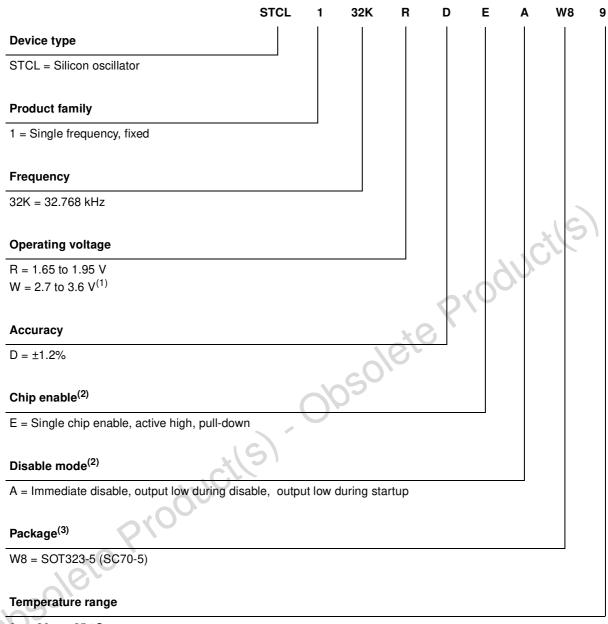
Trailer length = 160 mm minimum

Peel strength: conforms to EIA 481 standard

Min: 10 gm Max: 130 gm STCL132K Part numbering

9 Part numbering

Table 6. Ordering information scheme



 $9 = -30 \text{ to } +85 \text{ }^{\circ}\text{C}$

- 1. Contact local ST sales office for availability of the 3 V $\rm V_{CC}$ range ("W") version.
- 2. Contact local ST sales office for availability of other product options (chip enable active high or low, with or without internal pull-up or pull-down, possibility of various disable modes, startup procedures, output low or in high-impedance when disabled, etc.).
- 3. The shipping method is tape and reel only in $\mathsf{ECOPACK}^{\texttt{®}}$ packages.

Package marking STCL132K

10 Package marking

Table 7. Package marking

Part number	V _{CC} range	Topside marking ⁽¹⁾
STCL 1 32K R D E A W8 9	1.65 to 1.95 V	32Ax
STCL 1 32K W D E A W8 9	2.7 to 3.6 V	32Dx

^{1.} x = letter assigned to indicate assembly work week (i.e., A = WW01 and WW02, B = WW03 and WW04, C = WW05 and WW06..., Z = WW51, WW52, and WW53).

Obsolete Product(s). Obsolete Product(s)

STCL132K Revision history

11 Revision history

Table 8. Document revision history

	Date	Revision	Changes
	23-May-2007	1	Initial release.
	09-Aug-2007	2	Updated cover page; frequency accuracy in <i>Table 4</i> ; <i>Section 7:</i> Package mechanical data; and <i>Section 9: Part numbering.</i>
	28-Feb-2008	3	Document reformatted, added STCL132KWxxx device and commercial temperature range, <i>Chapter 10</i> , updated <i>Chapter 6</i> , <i>Chapter 8</i> , <i>Table 3</i> and <i>4</i> , <i>Figure 10</i> and <i>11</i> , <i>Chapter 9</i> .
	19-Mar-2008	4	Updated cover page, <i>Table 2</i> , <i>6</i> , <i>7</i> , and <i>Figure 2</i> , <i>8</i> ; minor text change.
	24-Apr-2008	5	Changed status for STCL132K, added note below <i>Table 6</i> .
Obsole	ie Pro	duct	Changed status for STCL132K, added note below Table 6.

Please Read Carefully:

Information in this document is provided solely in connection with ST products. STMicroelectronics NV and its subsidiaries ("ST") reserve the right to make changes, corrections, modifications or improvements, to this document, and the products and services described herein at any time, without notice.

All ST products are sold pursuant to ST's terms and conditions of sale.

Purchasers are solely responsible for the choice, selection and use of the ST products and services described herein, and ST assumes no liability whatsoever relating to the choice, selection or use of the ST products and services described herein.

No license, express or implied, by estoppel or otherwise, to any intellectual property rights is granted under this document. If any part of this document refers to any third party products or services it shall not be deemed a license grant by ST for the use of such third party products or services, or any intellectual property contained therein or considered as a warranty covering the use in any manner whatsoever of such third party products or services or any intellectual property contained therein.

UNLESS OTHERWISE SET FORTH IN ST'S TERMS AND CONDITIONS OF SALE ST DISCLAIMS ANY EXPRESS OR IMPLIED WARRANTY WITH RESPECT TO THE USE AND/OR SALE OF ST PRODUCTS INCLUDING WITHOUT LIMITATION IMPLIED WARRANTIES OF MERCHANTABILITY, FITNESS FOR A PARTICULAR PURPOSE (AND THEIR EQUIVALENTS UNDER THE LAWS OF ANY JURISDICTION), OR INFRINGEMENT OF ANY PATENT, COPYRIGHT OR OTHER INTELLECTUAL PROPERTY RIGHT.

UNLESS EXPRESSLY APPROVED IN WRITING BY AN AUTHORIZED ST REPRESENTATIVE, ST PRODUCTS ARE NOT RECOMMENDED, AUTHORIZED OR WARRANTED FOR USE IN MILITARY, AIR CRAFT, SPACE, LIFE SAVING, OR LIFE SUSTAINING APPLICATIONS, NOR IN PRODUCTS OR SYSTEMS WHERE FAILURE OR MALFUNCTION MAY RESULT IN PERSONAL INJURY, DEATH, OR SEVERE PROPERTY OR ENVIRONMENTAL DAMAGE. ST PRODUCTS WHICH ARE NOT SPECIFIED AS "AUTOMOTIVE GRADE" MAY ONLY BE USED IN AUTOMOTIVE APPLICATIONS AT USER'S OWN RISK.

Resale of ST products with provisions different from the statements and/or technical features set forth in this document shall immediately void any warranty granted by ST for the ST product or service described herein and shall not create or extend in any manner whatsoever, any liability of ST.

ST and the ST logo are trademarks or registered trademarks of ST in various countries.

Information in this document supersedes and replaces all information previously supplied.

The ST logo is a registered trademark of STMicroelectronics. All other names are the property of their respective owners.

© 2008 STMicroelectronics - All rights reserved

STMicroelectronics group of companies

Australia - Belgium - Brazil - Canada - China - Czech Republic - Finland - France - Germany - Hong Kong - India - Israel - Italy - Japan - Malaysia - Malta - Morocco - Singapore - Spain - Sweden - Switzerland - United Kingdom - United States of America

www.st.com